

Attorney Docket No. 057329-0001

Application No. 09/740,424

Amend
attach.
S. Davis
3/10/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Kiyotaka Tsukada et al.

Application No. : 09/740,424

Filing Date : December 19, 2000

Title : PRINTED-CIRCUIT BOARD AND METHOD
OF MANUFACTURE THEREOF

Examiner : Chris C. Chu

Group Art Unit : 2815

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I hereby certify that this correspondence is being deposited with the
United States Postal Service with sufficient postage as first class mail
in an envelope addressed to: Box Non-Fee Amendment, Commissioner
for Patents, Washington, D.C. 20231 on August 23, 2002By: [Signature]Name: Seis SturtevantAMENDMENT

Sir:

In response to the Office Action mailed May 23, 2002, please amend the above-identified application as follows.

In the Claims:

In accordance with 37 C.F.R. § 1.121(c)(1)(i), the following is a clean version of the amended claims. A marked-up version of the amended claims in accordance with 37 C.F.R. § 1.121(c)(1)(ii) is enclosed herewith. Claims 1 and 8 are amended, and claim 3 is canceled in this amendment.

- C1
1. (Twice Amended) A printed circuit board comprising: